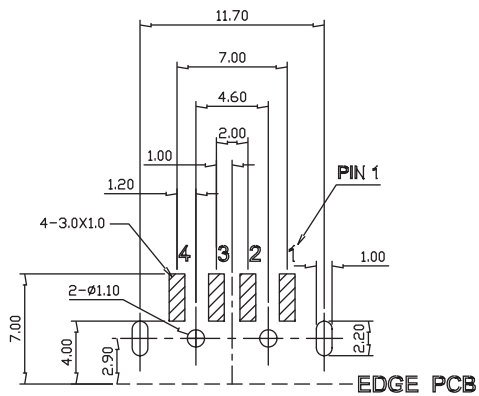
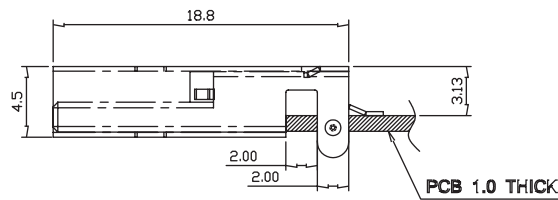
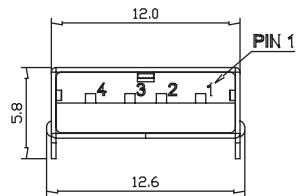


Specifications

Housing: Nylon PA9T glass filled
Shell: Brass with nickel plating
Contact: Phosphor bronze with gold/tin plating
Plating: 30u" gold

Peak reflow temperature time and duration = 260 degree C +/- 5 degree C for 3 +/- 0.5 seconds



**SUGGESTED PCB LAYOUT
TOP VIEW**

Ordering Information

AJP11G	4	4	1	3	0	0	X
Type	Positions	Contacts	Ports	Plating 3 = 30u"	Insert 1 = Black 2 = White		

Revision 1

Tolerance unless otherwise specified
.0 ± 0.3
.00 ± 0.20
.000 ± 0.075

METZ CONNECT	P/N: AJP11G4413-00X
Desc.: USB 2.0, horizontal edge mount, SMT	
Date: 9-11-06	Drawn By: Donna Mears
Dimensions in mm	Verified By: Mike Balekdjian